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United States Patent [19]

Osamu

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[54] MOLD TEMPERATURE CONTROLLER

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[**] Term: 14 Years

[21] Appl. No.: 723,519

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[30] Foreign Application Priority Data

Mar. 29, 1991 [JP] Japan 3-9097

[52] U.S. Cl. D10/49

[58] Field of Search 264/40.5, 40.6, 40.7;
425/143, 144; D10/49-52; D15/135

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[57] CLAIM

The ornamental design for a mold temperature controller, as shown and described.

DESCRIPTION

FIG. 1 is a front elevational view of the mold temperature controller showing my new design;

FIG. 2 is a rear elevational view thereof;

FIG. 3 is a left side elevational view thereof;

FIG. 4 is a right side elevational view thereof;

FIG. 5 is a top plan view thereof;

FIG. 6 is a bottom plan view thereof;

FIG. 7 is a perspective view taken from the top, front and right side of the mold temperature controller; and,

FIG. 8 is a perspective view taken from the top, rear and left side of the mold temperature controller.

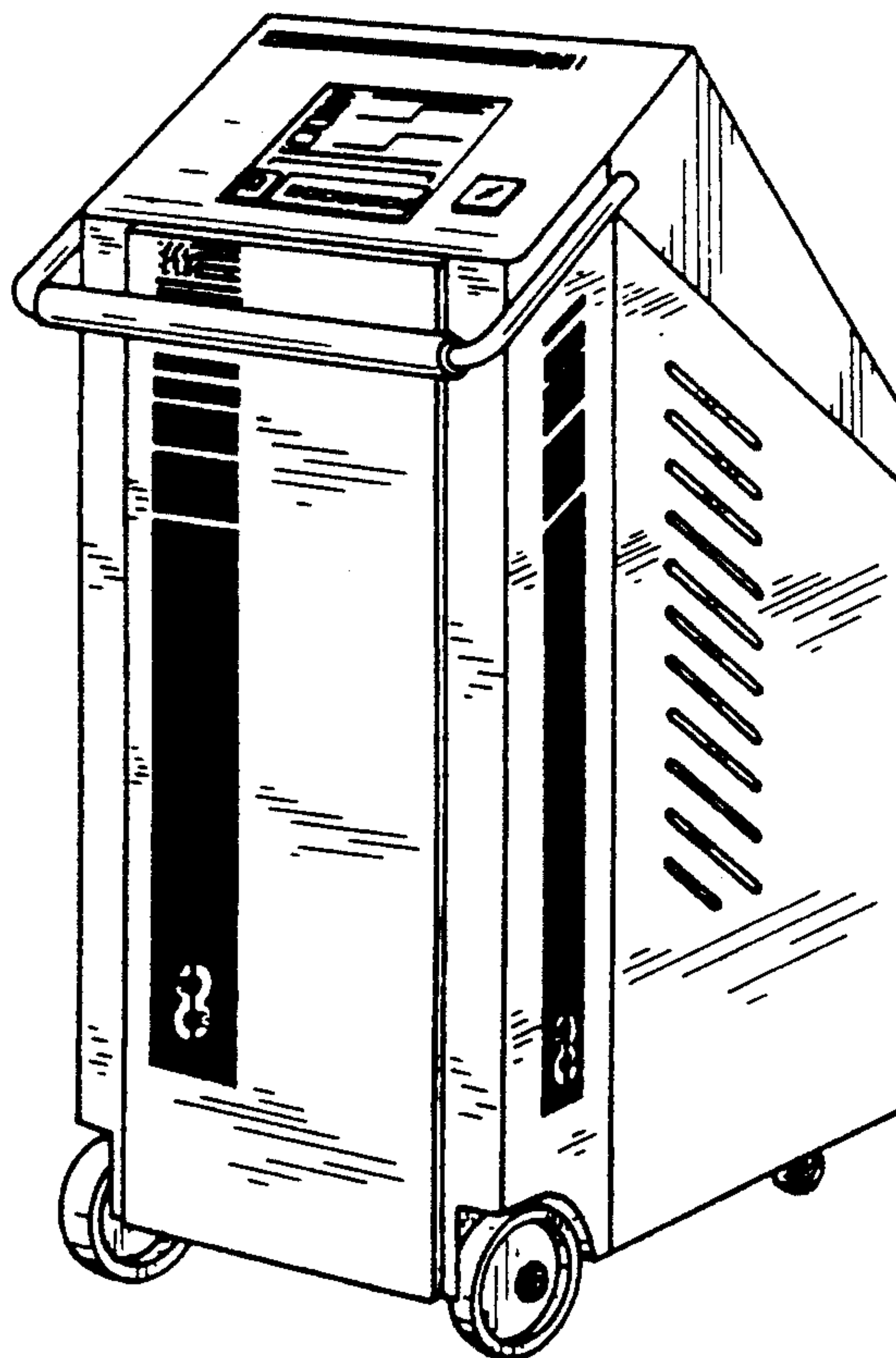


FIG. 1

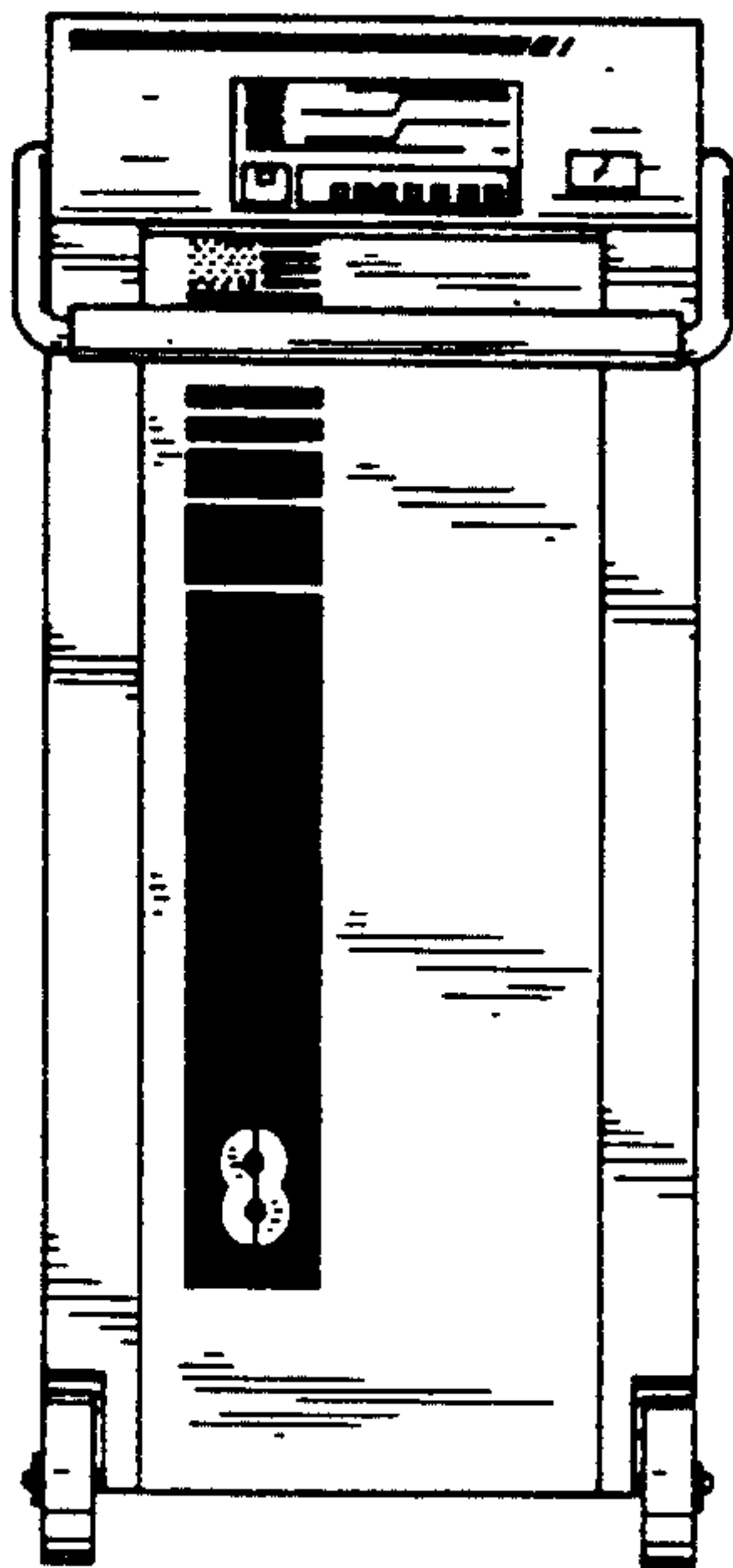


FIG. 2

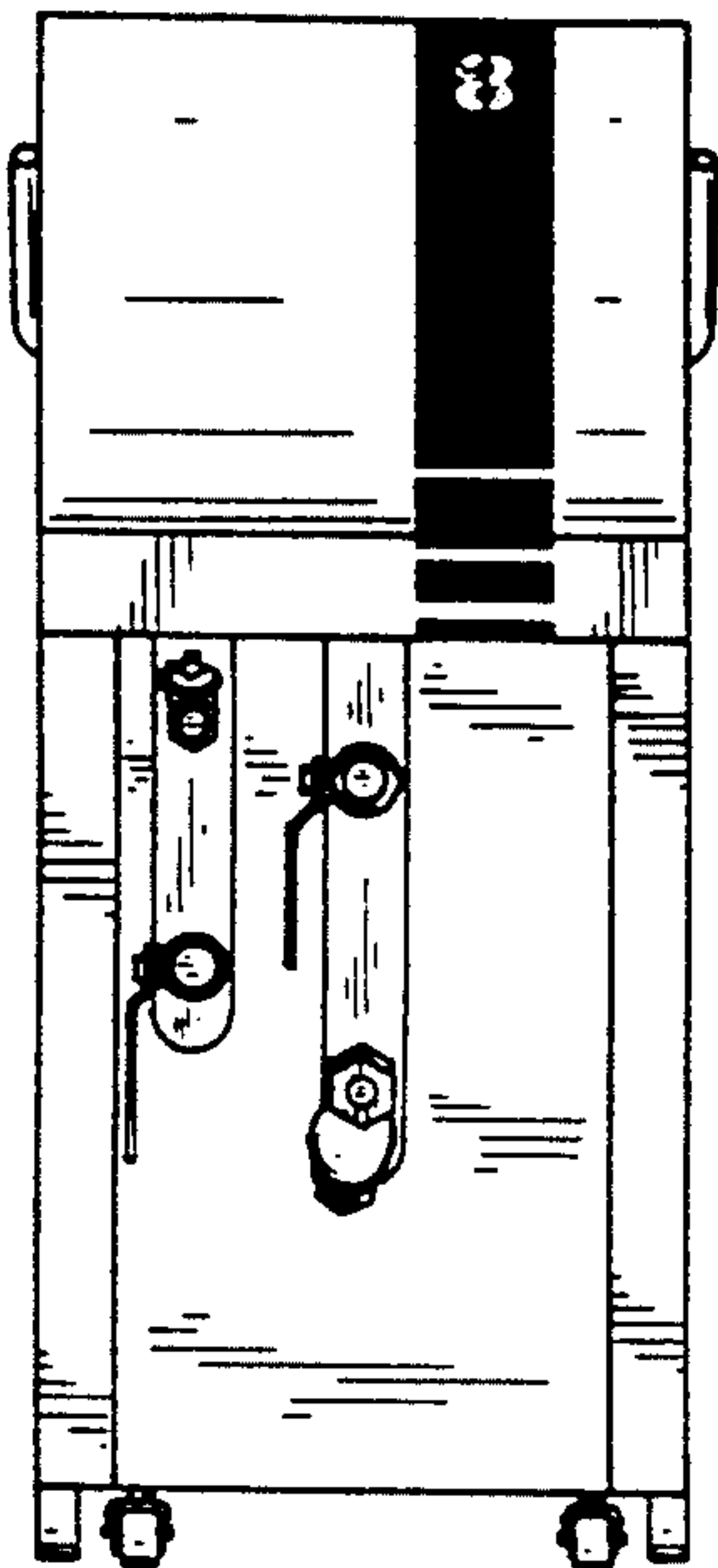


FIG. 3

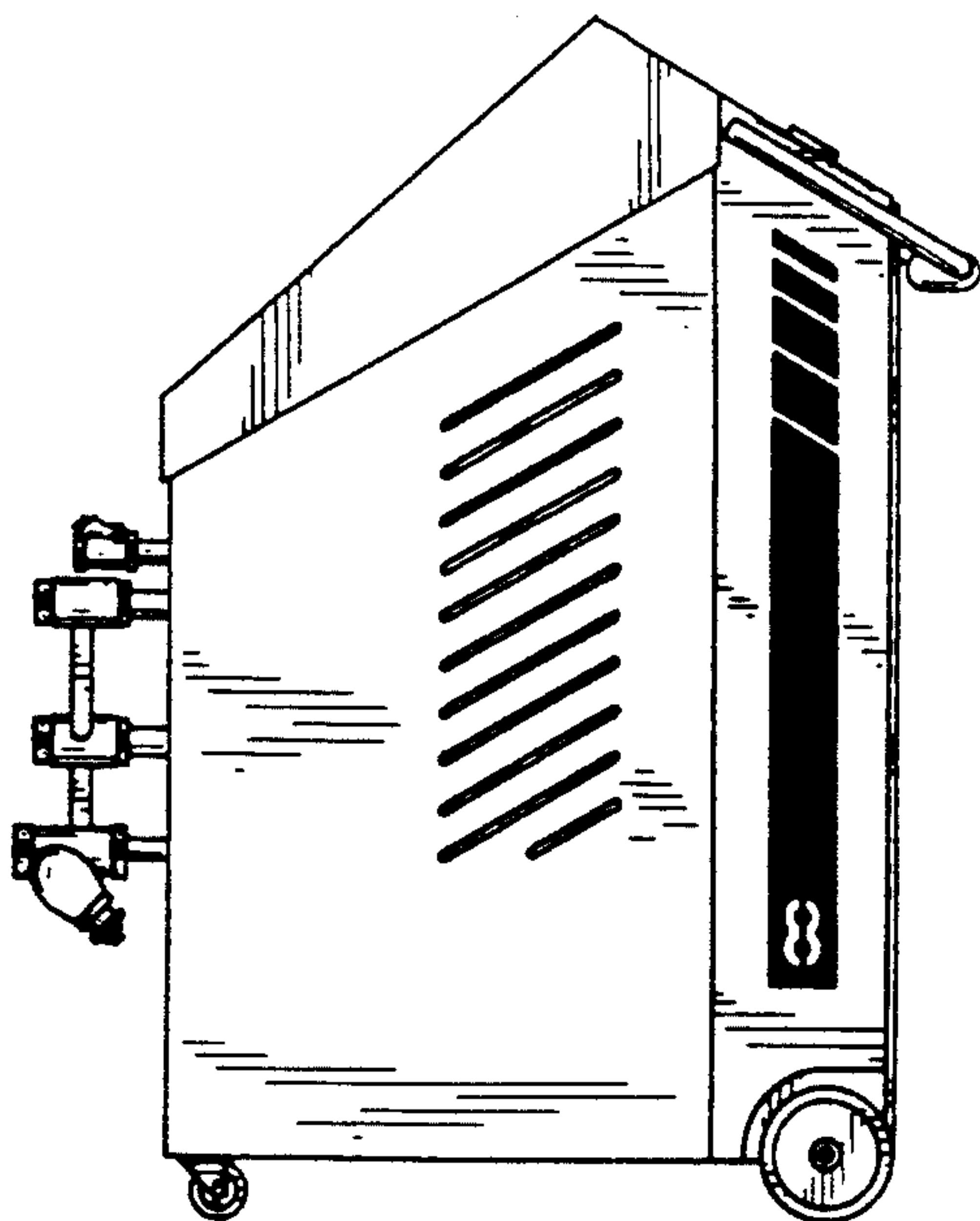


FIG. 4

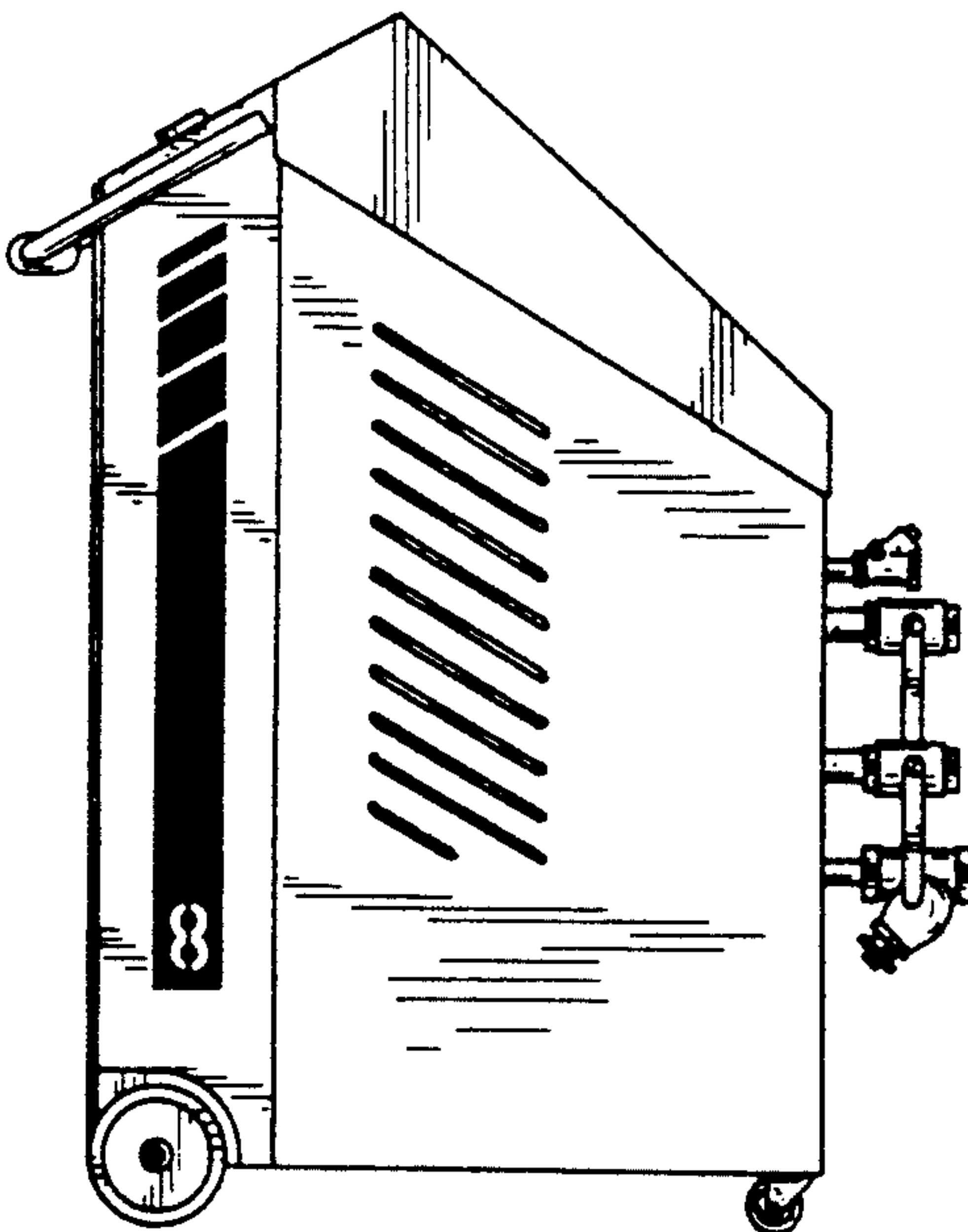


FIG. 5

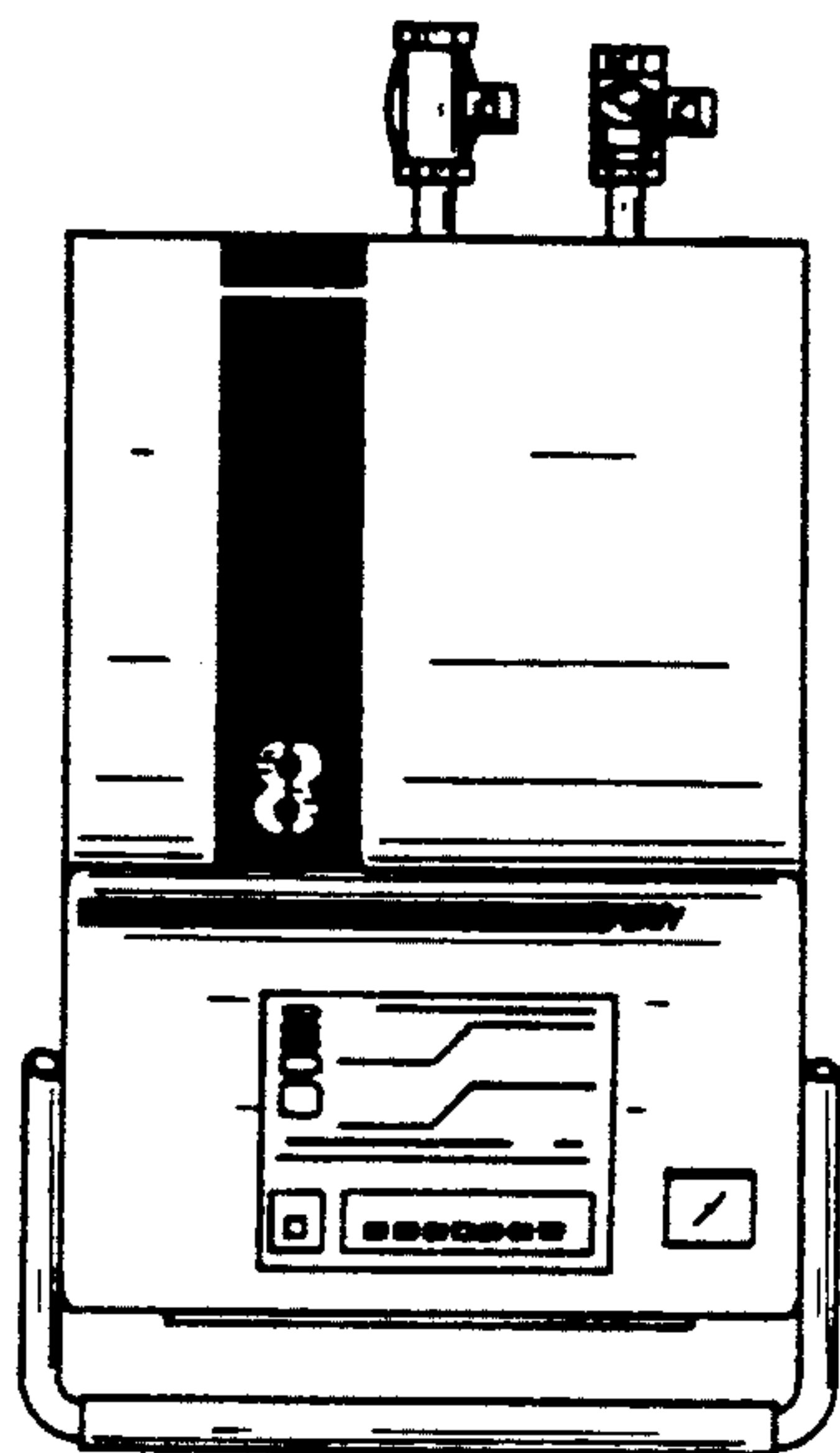


FIG. 6

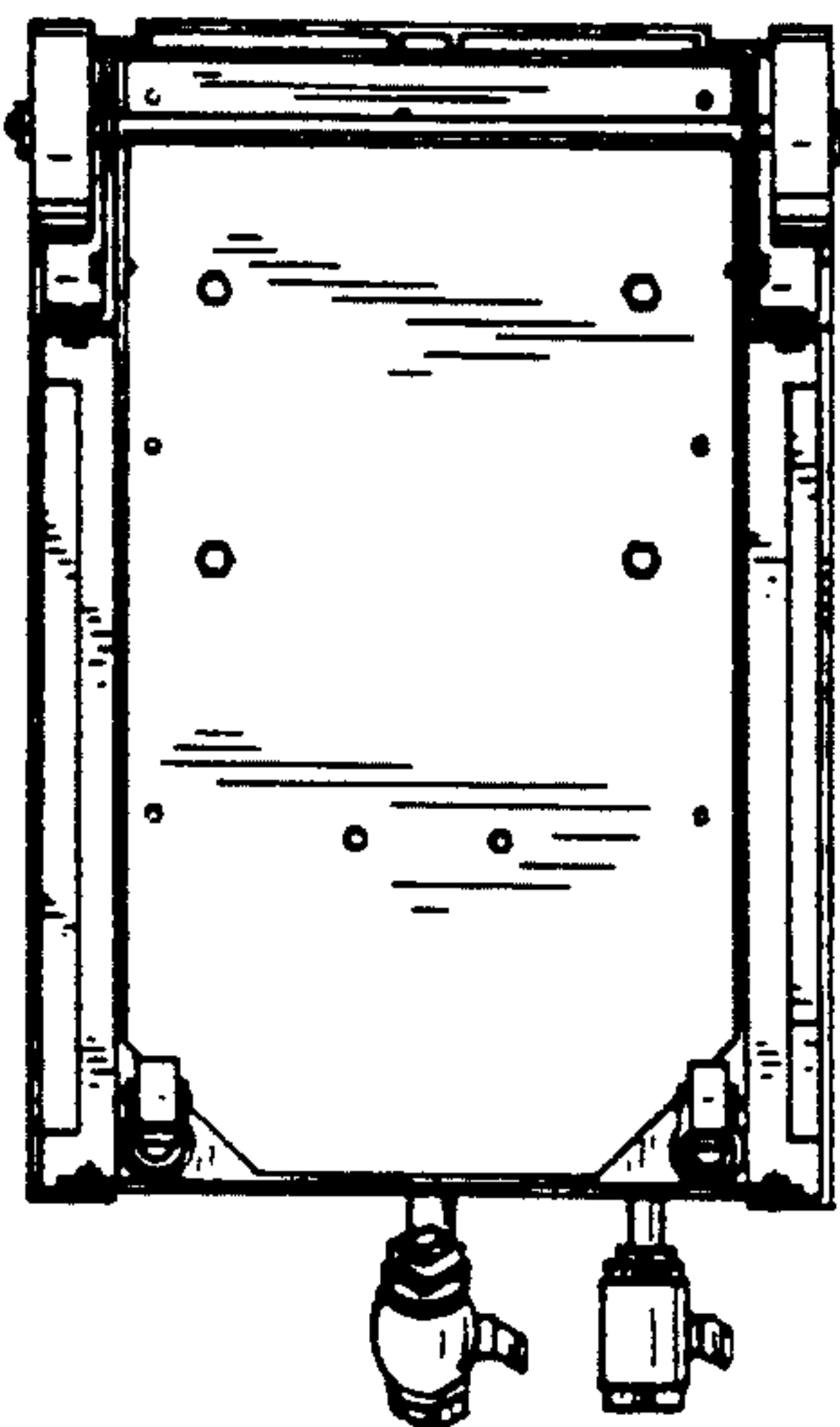


FIG. 7

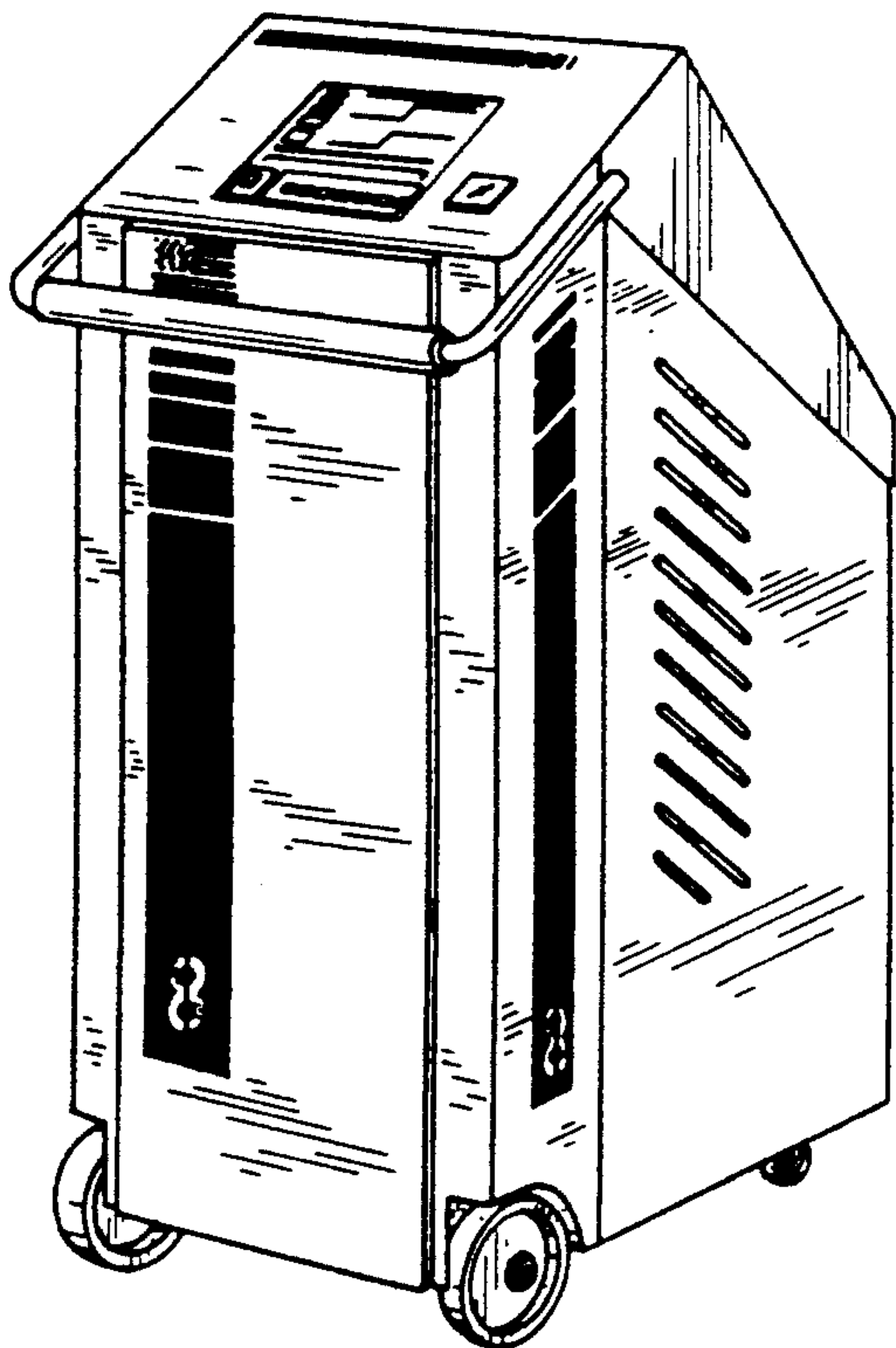


FIG. 8

